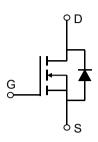
CRMEGL0606A

N-Channel 60V, 4.2mΩ Typ. Power MOSFET

Description

Features

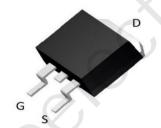
- 60V, 110A
- $R_{DS(ON)}$ Typ = 4.2m Ω @ V_{GS} = 10V $R_{DS(ON)}$ Typ = 5.7m Ω @ V_{GS} = 4.5V
- Advanced Split Gate Trench Technology
- Excellent R_{DS(ON)} and Low Gate Charge
- 100% UIS TESTED!
- 100% ΔVds TESTED!

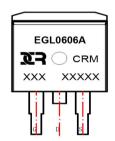


Schematic Diagram

Application

- Load Switch
- PWM Application
- Power Management





Marking and Pin Assignment

Package Marking and Ordering Information

Device	Marking	Package	Outline	Reel Size	Reel (pcs)	Per Carton (pcs)
CRMEGL0606A	CRMEGL0606A	TO-263-3L	TAPING	13"	800	4000

Absolute Maximum Ratings (@ $T_J = 25$ °C unless otherwise specified)

Symbol	Parameter		Value	Units
V_{DS}	Drain-to-Source Voltage		60	V
V_{GS}	Gate-to-Source Voltage		±20	V
	Continuous Drain Current	T _C = 25°C	110	Α
I _D	Continuous Drain Current	T _C = 100°C	66	Α
I _{DM}	Pulsed Drain Current (1)		440	Α
E _{AS}	Single Pulsed Avalanche Energy (2)		150	mJ
P_{D}	Power Dissipation	T _C = 25°C	114	W
$R_{ heta JC}$	Thermal Resistance, Junction to Case		1.1	°C/W
T_{J}, T_{STG}	Junction & Storage Temperature Range		-55 to 150	°C

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Electrical Characteristics (T_J = 25°C unless otherwise specified)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Uni
Off Chara	acteristics					
V _{(BR)DSS}	Drain-Source Breakdown Voltage	$I_D = 250 \mu A, V_{GS} = 0 V$	60	-	-	V
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 60V, V_{GS} = 0V$	-	-	1.0	μΑ
I _{GSS}	Gate-Body Leakage Current	$V_{DS} = 0V, V_{GS} = \pm 20V$	-	-	±100	nA
On Chara	acteristics				6	
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	1.2	1.7	2.4	V
R _{DS(ON)}	Static Drain-Source ON-Resistance ⁽³⁾	$V_{GS} = 10V, I_D = 20A$	-	4.2	5.5	mΩ
		V _{GS} = 4.5V, I _D = 15A	-	5.7	7.4	mΩ
Dynamic	Characteristics					
C _{iss}	Input Capacitance		-(2126	-	pF
C_{oss}	Output Capacitance	$V_{GS} = 0V, V_{DS} = 30V,$ f = 1MHz	X - \	657	-	pF
C_{rss}	Reverse Transfer Capacitance	1 – 1101112	-	27	-	pF
Q_g	Total Gate Charge		U -	30	-	nC
Q_gs	Gate Source Charge	$V_{GS} = 0 \text{ to } 10V$ $V_{DS} = 30V, I_{D} = 20A$	-	4.5	-	nC
Q_{gd}	Gate Drain("Miller") Charge	V _{DS} = 30 V, I _D = 20A	-	5	-	nC
Switchin	g Characteristics					
t _{d(on)}	Turn-On DelayTime	.r ()	-	6.5	-	ns
t_r	Turn-On Rise Time	$V_{GS} = 10V, V_{DD} = 30V$	-	8	-	ns
$t_{\text{d(off)}}$	Turn-Off DelayTime	$I_D = 20A$, $R_{GEN} = 6\Omega$	-	38	-	ns
t_f	Turn-Off Fall Time		-	16	-	ns
Drain-So	urce Diode Characteristics and M	Max Ratings				
Is	Maximum Continuous Drain to Source Diode Forward Current			-	110	Α
I _{SM}	Maximum Pulsed Drain to Source Diode	Forward Current	-	-	440	А
V_{SD}	Drain to Source Diode Forward Voltage	V _{GS} = 0V, I _S = 20A	-	-	1.2	V
trr	Body Diode Reverse Recovery Time	1 - 004 - 4:/4+ - 4004/	-	39	-	ns
Qrr	Body Diode Reverse Recovery Charge	$I_F = 20A$, di/dt = 100A/us	-	45	-	nC

Notes:

^{1.} Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature.

^{2.} E_{AS} condition: Starting T_J =25°C, V_{DD} =30V, V_G =10V, R_G =25ohm, L=0.5mH, I_{AS} =24.5A

^{3.} Pulse Test: Pulse Width≤300µs, Duty Cycle≤0.5%.

Typical Performance Characteristics

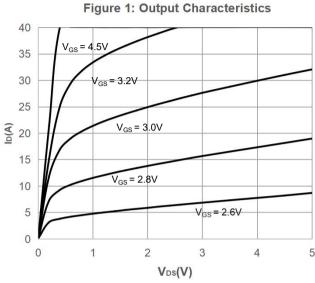


Figure 3: On-resistance vs. Drain Current

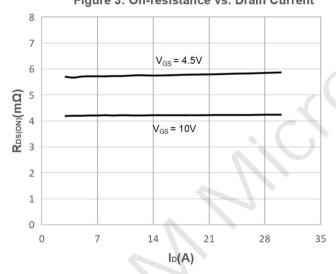


Figure 5: Gate Charge Characteristics

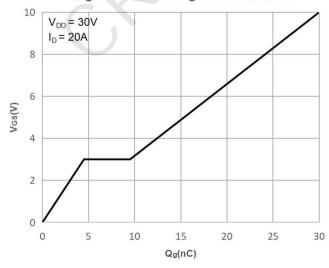


Figure 2: Typical Transfer Characteristics

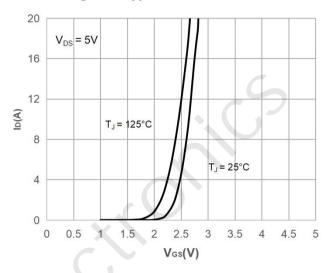


Figure 4: Body Diode Characteristics

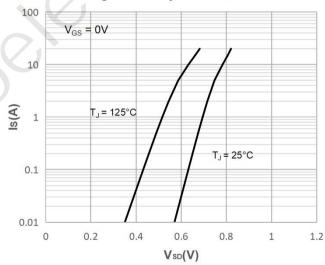
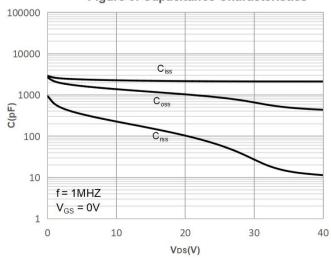


Figure 6: Capacitance Characteristics

Version: 1.2



Typical Performance Characteristics

Figure 7: Normalized Breakdown voltage vs.
Junction Temperature

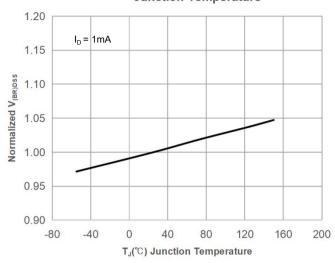


Figure 9: Maximum Safe Operating Area

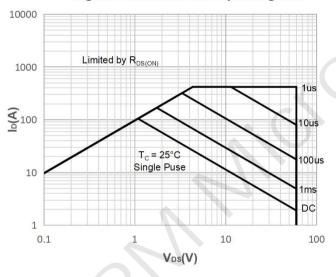


Figure 11: Normalized Maximum Transient

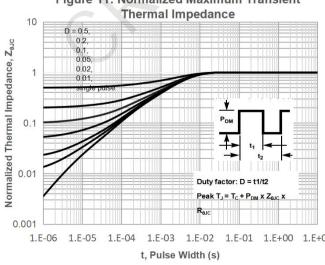


Figure 8: Normalized on Resistance vs. Junction Temperature

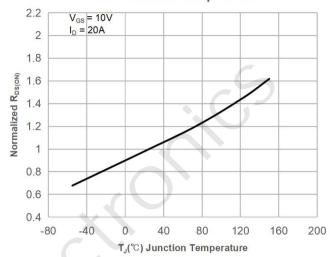


Figure 10: Maximum Continuous Drian
Current vs. Case Temperature

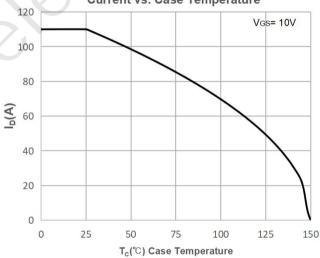
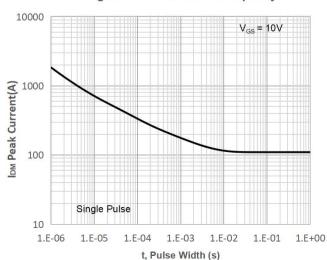


Figure 12: Peak Current Capacity



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Test Circuit

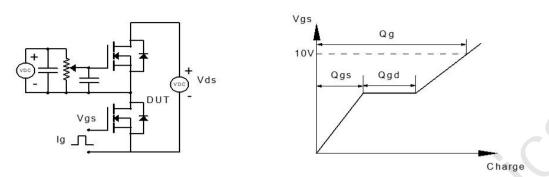


Figure 1: Gate Charge Test Circuit & Waveform

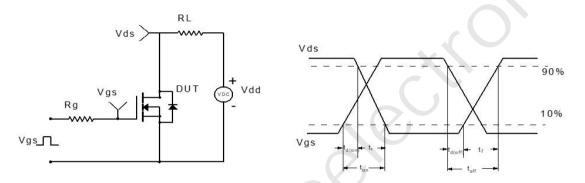


Figure 2: Resistive Switching Test Circuit & Waveform

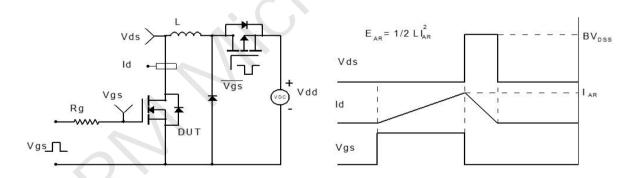


Figure 3: Unclamped Inductive Switching Test Circuit& Waveform

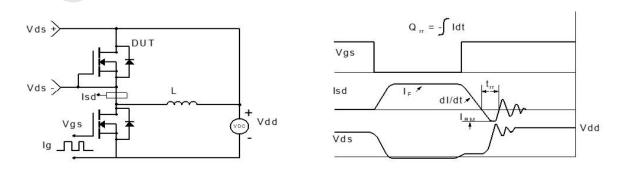
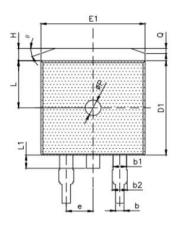


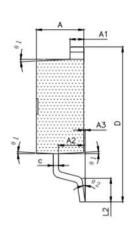
Figure 4: Diode Recovery Test Circuit & Waveform

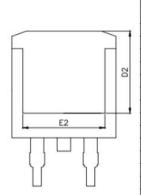
CRMEGL0606A

N-Channel 60V, 4.2mΩ Typ. Power MOSFET

Package Mechanical Data(TO-263-3L)







SYMBOL	MILLIMETER				
OTTOBOL	MIN	NOM	MAX		
Α	4.40	4.50	4.60		
A1	1.20	1.30	1.40		
A2	2.30	2.40	2.50		
A3	0.03	0.13	0.23		
b	0.70	0.80	0.90		
b1	1.21	1.27	1.40		
b2	1.25	1.35	1.45		
С	0.40	0.50	0.60		
D	14.80	15.10	15.40		
D1	9.10	9.20	9.30		
D2	8.00	-			
E	9.70	9.90	10.20		
E1	9.68	9.88	10.08		
E2	7.80				
е	2.54 (BSC)				
Н	1.00	1.20	1.40		
L	4.30	4.60	4.90		
L1	1.10	1.30	1.50		
L2	2.10	2.30	2.50		
ΦP	1.40	1.50	1.60		
Q	0.50 (REF)				
θ	16*	20° 24°			
91	1*	3*	5*		
62	0,	_	9.		

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